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FXLA101

Low-Voltage Dual-Supply 1-Bit Voltage Translator with Auto Direction Sensing

Features

- Bi-Directional Interface between Two Levels: from 1.1V to 3.6V
- Fully Configurable: Inputs and Outputs Track V_{CC}
- Non-Preferential Power-Up; Either V_{CC} May Be Powered Up First
- Outputs Switch to 3-State if Either V_{CC} is at GND
- Power-Off Protection
- Bus-Hold on Data Inputs Eliminates the Need for Pull-Up Resistors; Do Not Use Pull-Up Resistors on A or B Ports
- Control Input (/OE) Referenced to V_{CCA} Voltage
- Packaged in MicroPak™ 6 (1.00mm x 1.45mm)
- Direction Control Not Necessary
- 100Mbps Throughput when Translating Between 1.8V and 2.5V
- ESD Protection Exceeds:
 - 8kV HBM (per JESD22-A114 & Mil Std 883e 3015.7)
 - 2kV CDM (per ESD STM 5.3)

Applications

- Cell Phones, PDAs, Digital Cameras, Portable GPS

Description

The FXLA101 is a configurable dual-voltage supply translator for both uni-directional and bi-directional voltage translation between two logic levels. The device allows translation between voltages as high as 3.6V to as low as 1.1V. The A port tracks the V_{CCA} level and the B port tracks the V_{CCB} level. This allows for bi-directional voltage translation over a variety of voltage levels: 1.2V, 1.5V, 1.8V, 2.5V, and 3.3V.

The device remains in three-state as long as either $V_{CC}=0V$, allowing either V_{CC} to be powered up first. Internal power-down control circuits place the device in 3-state if either V_{CC} is removed.

The /OE input, when HIGH, disables both the A and B ports by placing them in a 3-state condition. The /OE input is supplied by V_{CCA} .

The FXLA101 supports bi-directional translation without the need for a direction control pin. The two ports of the device have auto-direction sense capability. Either port may sense an input signal and transfer it as an output signal to the other port.

Ordering Information

Part Number	Top Mark	Operating Temperature Range	Package	Packing Method
FXLA101L6X	XK	-40 to 85°C	6-Lead MicroPak™ 1.00mm x 1.45mm Package	5K Units Tape and Reel
FXLA101FHX	XK		6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch	

Pin Configuration

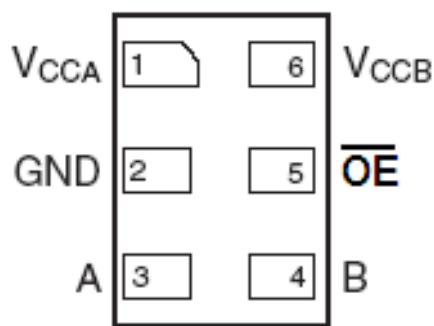


Figure 1. Pin Configuration (Top Through View)

Pin Definitions

Pin #	Name	Description
1	V _{CCA}	A-Side Power Supply
2	GND	Ground
3	A	A Side Input or 3-State Output
4	B	B Side Input or 3-State Output
5	/OE	Output Enable Input
6	V _{CCB}	B Side Power supply

Functional Diagram

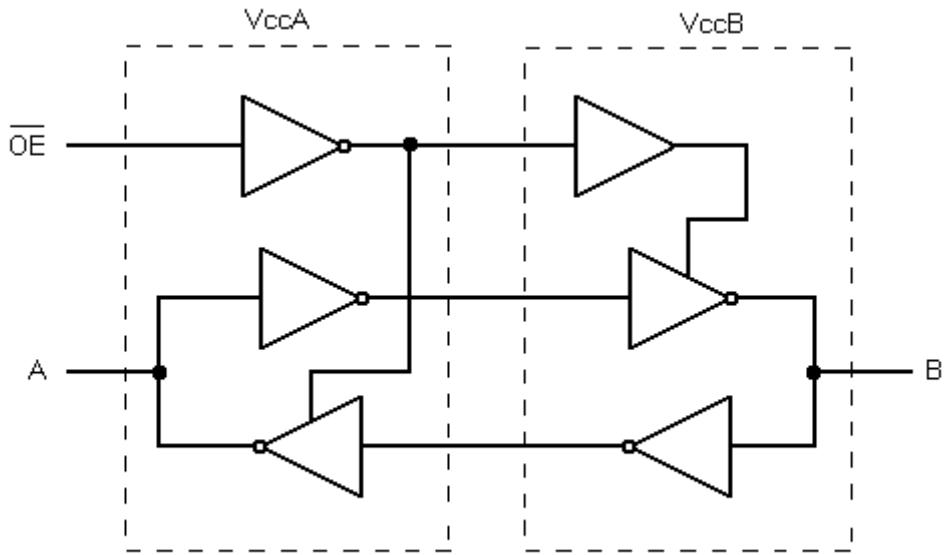


Figure 2. Functional Diagram

Function Table

Control	Outputs
/OE	
L	Normal Operation
H	3-State

H = HIGH Logic Level

L = LOW Logic Level

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Conditions	Min.	Max.	Unit
V _{CC}	Supply Voltage	V _{CCA}	-0.5	4.6	V
		V _{CCB}	-0.5	4.6	
V _I	DC Input Voltage	I/O Ports A and B	-0.5	4.6	V
		Control Input (/OE)	-0.5	4.6	
V _O	Output Voltage ⁽²⁾	Output 3-State	-0.5	4.6	V
		Output Active (A _n)	-0.5	V _{CCA} +0.5	
		Output Active (B _n)	-0.5	V _{CCB} +0.5	
I _{IK}	DC Input Diode Current	V _I <0V		-50	mA
I _{OK}	DC Output Diode Current	V _O <0V		-50	mA
		V _O >V _{CC}		+50	
I _{OH} /I _{OL}	DC Output Source/Sink Current		-50	+50	mA
I _{CC}	DC V _{CC} or Ground Current (per Supply Pin)			±100	mA
T _{STG}	Storage Temperature Range		-65	+150	°C
P _D	Power Dissipation			4.5	mW
ESD	Human Body Model, JESD22-A114	B Port I/O to GND		12	kV
		A Port I/O to GND		8	
	Charged Device Model, JESD22-C101			2	

Notes:

- I_O absolute maximum ratings must be observed.
- All unused inputs and input/outputs must be held at V_{CCi} or GND.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Max.	Unit
V _{CC}	Power Supply	Operating V _{CCA} or V _{CCB}	1.1	3.6	V
V _{IN}	Input Voltage	Ports A and B	0	3.6	V
		Control Input (/OE)	0	V _{CCA}	V
T _A	Operating Temperature, Free Air		-40	+85	°C
dt/dV	Minimum Input Edge Rate	V _{CCA/B} = 1.1 to 3.6V		10	ns/V
θ _{JA}	Thermal Resistance	Micropak-6		350	°C/W
		Micropak2-6		560	

Power-Up/Power-Down Sequence

FXL translators offer an advantage in that either V_{CC} may be powered up first. This benefit derives from the chip design. When either V_{CC} is at 0V, outputs are in a high-impedance state. The control input (/OE) is designed to track the V_{CCA} supply. A pull-up resistor tying /OE to V_{CCA} should be used to ensure that bus contention, excessive currents, or oscillations do not occur during power-up or power-down. The size of the pull-up resistor is based upon the current-sinking capability of the device driving the /OE pin.

The recommended power-up sequence is:

1. Apply power to the first V_{CC} .
2. Apply power to the second V_{CC} .
3. Drive the /OE input LOW to enable the device.

The recommended power-down sequence is:

1. Drive /OE input HIGH to disable the device.
2. Remove power from either V_{CC} .
3. Remove power from other V_{CC} .

Pull-Up/Pull-Down Resistors

Do not use pull-up or pull-down resistors. This device has bus-hold circuits: pull-up or pull-down resistors are not recommended because they interfere with the output state. The current through these resistors may exceed the hold drive, $I_{I(HOLD)}$ and/or $I_{I(OD)}$ bus-hold currents. The bus-hold feature eliminates the need for extra resistors.

DC Electrical Characteristics

 $T_A = -40$ to 85°C .

Symbol	Parameter	Conditions	V_{CCA} (V)	V_{CCB} (V)	Min.	Typ.	Max.	Units	
V_{IHA}	High-Level Input Voltage	Data Inputs A_n Control Pin /OE	2.70 to 3.60	1.10 to 3.60	2.00			V	
			2.30 to 2.70		1.60				
			1.65 to 2.30		.65x V_{CCA}				
			1.40 to 1.65		.65x V_{CCA}				
			1.10 to 1.40		.90x V_{CCA}				
V_{IHB}		Data Inputs B_n	2.70 to 3.60	2.00				V	
			2.30 to 2.70	1.60					
			1.65 to 2.30	.65x V_{CCB}					
			1.40 to 1.65	.65x V_{CCB}					
			1.10 to 1.40	.90x V_{CCB}					
V_{ILA}	Low-Level Input Voltage	Data Inputs A_n Control Pin /OE	2.70 to 3.60	1.10 to 3.60			.80	V	
			2.30 to 2.70				.70		
			1.65 to 2.30				.35x V_{CCA}		
			1.40 to 1.65				.35x V_{CCA}		
			1.10 to 1.40				.10x V_{CCA}		
V_{ILB}		Data Inputs B_n	2.70 to 3.60	2.70 to 3.60			.80	V	
			2.30 to 2.70	2.30 to 2.70			.70		
			1.65 to 2.30	1.65 to 2.30			.35x V_{CCB}		
			1.40 to 1.65	1.40 to 1.65			.35x V_{CCB}		
			1.10 to 1.40	1.10 to 1.40			.10x V_{CCB}		
V_{OHA}	High-Level Output Voltage ⁽³⁾	$I_{OH} = -4\mu\text{A}$	1.10 to 3.60	1.10 to 3.60	$V_{CCA} - .40$			V	
V_{OHB}		$I_{OH} = -4\mu\text{A}$	1.10 to 3.60	1.10 to 3.60	$V_{CCB} - .40$				
V_{OLA}	Low-Level Output Voltage ⁽³⁾	$I_{OL} = 4\mu\text{A}$	1.10 to 3.60	1.10 to 3.60			.4	V	
V_{OLB}		$I_{OL} = 4\mu\text{A}$	1.10 to 3.60	1.10 to 3.60			.4		
$I_{I(HOLD)}$	Bus-Hold Input Minimum Drive Current	$V_{IN} = 0.80\text{V}$	3.00	3.00	75.0			μA	
		$V_{IN} = 2.00\text{V}$	3.00	3.00	-75.0				
		$V_{IN} = 0.7\text{V}$	2.30	2.30	45.0				
		$V_{IN} = 1.60\text{V}$	2.30	2.30	-45.0				
		$V_{IN} = 0.57\text{V}$	1.65	1.65	25.0				
		$V_{IN} = 1.07\text{V}$	1.65	1.65	-25.0				
		$V_{IN} = 0.49\text{V}$	1.40	1.40	11.0				
		$V_{IN} = 0.91\text{V}$	1.40	1.40	-11.0				
		$V_{IN} = 0.11\text{V}$	1.10	1.10	4.0				
		$V_{IN} = 0.99\text{V}$	1.10	1.10	-4.0				

Continued on following page...

DC Electrical Characteristics (Continued)

 $T_A = -40$ to 85°C .

Symbol	Parameter	Conditions	V_{CCA} (V)	V_{CCB} (V)	Min.	Max.	Units
$I_{I(ODH)}$	Bus-Hold Input Overdrive High Current ⁽⁴⁾	Data Inputs A_n, B_n	3.60	3.60	450.00		μA
			2.70	2.70	300.00		
			1.95	1.95	200.00		
			1.60	1.60	120.00		
			1.40	1.40	80.00		
$I_{I(ODL)}$	Bus-Hold Input Overdrive Low Current ⁽⁵⁾	Data Inputs A_n, B_n	3.60	3.60	-450.00		μA
			2.70	2.70	-300.00		
			1.95	1.95	-200.00		
			1.60	1.60	-120.00		
			1.40	1.40	-80.00		
I_I	Input Leakage Current	Control Inputs /OE, $V_I = V_{CCA}$ or GND	1.10 to 3.60	3.60		± 1.0	μA
I_{OFF}	Power-Off Leakage Current	$A_n, V_O = 0\text{V}$ to 3.6V	0	3.6		± 2.0	μA
		$B_n, V_O = 0\text{V}$ to 3.6V	3.60	0		± 2.0	
I_{OZ}	3-State Output Leakage	$A_n, B_n, V_O = 0\text{V}$ or 3.6V , /OE = V_{IH}	3.6	3.60		± 5.0	μA
		$A_n, V_O = 0\text{V}$ or 3.6V , /OE = GND	3.60	0		± 5.0	
		$B_n, V_O = 0\text{V}$ or 3.6V , /OE = GND	0	3.60		± 5.0	
$I_{CCA/B}$	Quiescent Supply Current ^(6, 7)	$V_I = V_{CCI}$ or GND; $I_O = 0$, /OE = GND	1.10 to 3.60	1.10 to 3.60		10.0	μA
I_{CCZ}		$V_I = V_{CCI}$ or GND; $I_O = 0$, /OE = V_{IH}	1.10 to 3.60	1.10 to 3.60		10.0	μA
I_{CCA}	Quiescent Supply Current	$V_I = V_{CCB}$ or GND; $I_O = 0$ B-to-A Direction, /OE = GND	0	1.10 to 3.60		-10.0	μA
		$V_I = V_{CCA}$ or GND; $I_O = 0$ A-to-B Direction	1.10 to 3.60	0		10.0	
I_{CCB}		$V_I = V_{CCA}$ or GND; $I_O = 0$ A-to-B Direction, /OE = GND	1.10 to 3.60	0		-10.0	μA
		$V_I = V_{CCB}$ or GND; $I_O = 0$ B-to-A Direction	0	1.10 to 3.60		10.0	

Notes:

3. This is the output voltage for static conditions. Dynamic drive specifications are given in the Dynamic Output Electrical Characteristics table.
4. An external drive must source at least the specified current to switch LOW-to-HIGH.
5. An external drive must source at least the specified current to switch HIGH-to-LOW.
6. V_{CCI} is the V_{CC} associated with the input side.
7. Reflects current per supply, V_{CCA} or V_{CCB} .

Dynamic Output Electrical Characteristic

A Port (A_n)

Output Load: $C_L=15\text{pF}$, $R_L \geq M\Omega$ ($C_{I/O}=4\text{pF}$), $T_A=-40$ to 85°C

Symbol	Parameter	$V_{CCA}=3.0\text{V}$ to 3.6V		$V_{CCA}=2.3\text{V}$ to 2.7V		$V_{CCA}=1.65\text{V}$ to 1.95V		$V_{CCA}=1.4\text{V}$ to 1.6V		$V_{CCA}=1.1\text{V}$ to 1.3V		Units
		Typ.	Max.	Typ.	Max.	Typ.	Max.	Typ.	Max.	Typ.	Max.	
t_{rise}	Output Rise Time A Port ⁽⁹⁾		3.0		3.5		4.0		5.0	7.5		ns
t_{fall}	Output Fall Time A Port ⁽¹⁰⁾		3.0		3.5		4.0		5.0	7.5		ns
I_{OHD}	Dynamic Output Current High ⁽⁹⁾	-11.4		-7.5		-4.7		-3.2		-1.7		mA
I_{OLD}	Dynamic Output Current Low ⁽¹⁰⁾	+11.4		+7.5		+4.7		+3.2		+1.7		mA

B Port (B_n)

Output Load: $C_L=15\text{pF}$, $R_L \geq M\Omega$ ($C_{I/O}=5\text{pF}$), $T_A=-40$ to 85°C

Symbol	Parameter	$V_{CCB}=3.0\text{V}$ to 3.6V		$V_{CCB}=2.3\text{V}$ to 2.7V		$V_{CCB}=1.65\text{V}$ to 1.95V		$V_{CCB}=1.4\text{V}$ to 1.6V		$V_{CCB}=1.1\text{V}$ to 1.3V		Units
		Typ.	Max.	Typ.	Max.	Typ.	Max.	Typ.	Max.	Typ.	Max.	
t_{rise}	Output Rise Time B Port ⁽⁹⁾		3.0		3.5		4.0		5.0	7.5		ns
t_{fall}	Output Fall Time B Port ⁽¹⁰⁾		3.0		3.5		4.0		5.0	7.5		ns
I_{OHD}	Dynamic Output Current High ⁽⁹⁾	-12.0		-7.9		-5.0		-3.4		-1.8		mA
I_{OLD}	Dynamic Output Current Low ⁽¹⁰⁾	+12.0		+7.9		+5.0		+3.4		+1.8		mA

Notes:

8. Dynamic output characteristics are guaranteed, but not tested.
9. See Figure 7.
10. See Figure 8.

AC Characteristics

$V_{CCA} = 3.0V$ to $3.6V$, $T_A = -40$ to $85^\circ C$

Symbol	Parameter	$V_{CCB} = 3.0V$ to $3.6V$		$V_{CCB} = 2.3V$ to $2.7V$		$V_{CCB} = 1.65V$ to $1.95V$		$V_{CCB} = 1.4V$ to $1.6V$		$V_{CCB} = 1.1V$ to $1.3V$	
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Typ.	
t_{PLH}, t_{PHL}	A to B	0.2	4.0	0.3	4.2	0.5	5.4	0.6	6.8	6.9	ns
	B to A	0.2	4.0	0.2	4.1	0.3	5.0	0.5	6.0	4.5	ns
t_{PZL}, t_{PZH}	/OE to A, /OE to B		1.7		1.7		1.7		1.7	1.7	μs
t_{SKW}	A Port, B Port ⁽¹¹⁾		0.5		0.5		0.5		1.0	1.0	ns

$V_{CCA} = 2.3V$ to $2.7V$, $T_A = -40$ to $85^\circ C$

Symbol	Parameter	$V_{CCB} = 3.0V$ to $3.6V$		$V_{CCB} = 2.3V$ to $2.7V$		$V_{CCB} = 1.65V$ to $1.95V$		$V_{CCB} = 1.4V$ to $1.6V$		$V_{CCB} = 1.1V$ to $1.3V$	
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Typ.	
t_{PLH}, t_{PHL}	A to B	0.2	4.1	0.4	4.5	0.5	5.6	0.8	6.9	7.0	ns
	B to A	0.3	4.2	0.4	4.5	0.5	5.5	0.5	6.5	4.8	ns
t_{PZL}, t_{PZH}	/OE to A, /OE to B		1.7		1.7		1.7		1.7	1.7	μs
t_{SKW}	A Port, B Port ⁽¹¹⁾		0.5		0.5		0.5		1.0	1.0	ns

$V_{CCA} = 1.65V$ to $1.95V$, $T_A = -40$ to $85^\circ C$

Symbol	Parameter	$V_{CCB} = 3.0V$ to $3.6V$		$V_{CCB} = 2.3V$ to $2.7V$		$V_{CCB} = 1.65V$ to $1.95V$		$V_{CCB} = 1.4V$ to $1.6V$		$V_{CCB} = 1.1V$ to $1.3V$	
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Typ.	
t_{PLH}, t_{PHL}	A to B	0.3	5.0	0.5	5.5	0.8	6.7	0.9	7.5	7.5	ns
	B to A	0.5	5.4	0.5	5.6	0.8	6.7	1.0	7.0	5.4	ns
t_{PZL}, t_{PZH}	/OE to A, /OE to B		1.7		1.7		1.7		1.7	1.7	μs
t_{SKW}	A Port, B Port ⁽¹¹⁾		0.5		0.5		0.5		1.0	1.0	ns

Note:

- Skew is the variation of propagation delay between output signals and applies only to output signals on the same port (A_n or B_n) and switching with the same polarity (LOW-to-HIGH or HIGH-to-LOW) (see Figure 10). Skew is guaranteed, but not tested.

AC Characteristics (Continued) $V_{CCA} = 1.4V$ to $1.6V$, $T_A = -40$ to $85^\circ C$

Symbol	Parameter	$V_{CCB} = 3.0V$ to $3.6V$		$V_{CCB} = 2.3V$ to $2.7V$		$V_{CCB} = 1.65V$ to $1.95V$		$V_{CCB} = 1.4V$ to $1.6V$		$V_{CCB} = 1.1V$ to $1.3V$	
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Typ.	
t_{PLH}, t_{PHL}	A to B	0.5	6.0	0.5	6.5	1.0	7.0	1.0	8.5	7.9	ns
	B to A	0.6	6.8	0.8	6.9	0.9	7.5	1.0	8.5	6.1	ns
t_{PZL}, t_{PZH}	/OE to A, /OE to B		1.7		1.7		1.7		1.7	1.7	μs
t_{SKW}	A Port, B Port ⁽¹²⁾		1.0		1.0		1.0		1.0	1.0	ns

 $V_{CCA} = 1.1V$ to $1.3V$, $T_A = -40$ to $85^\circ C$

Symbol	Parameter	$V_{CCB} = 3.0V$ to $3.6V$		$V_{CCB} = 2.3V$ to $2.7V$		$V_{CCB} = 1.65V$ to $1.95V$		$V_{CCB} = 1.4V$ to $1.6V$		$V_{CCB} = 1.1V$ to $1.3V$	
		Typ.	Typ.	Typ.	Typ.	Typ.	Typ.	Typ.	Typ.	Typ.	
t_{PLH}, t_{PHL}	A to B	4.6	4.8	5.4	6.2	9.2	ns				
	B to A	6.8	7.0	7.4	7.8	9.1	ns				
t_{PZL}, t_{PZH}	/OE to A, /OE to B	1.7	1.7	1.7	1.7	1.7	μs				
t_{SKW}	A Port, B Port ⁽¹²⁾	1.0	1.0	1.0	1.0	1.0	ns				

Note:

12. Skew is the variation of propagation delay between output signals and applies only to output signals on the same port (A_n or B_n) and switching with the same polarity (LOW-to-HIGH or HIGH-to-LOW) (see *Figure 10*). Skew is guaranteed, but not tested.

Maximum Data Rate

$T_A = -40$ to 85°C .

V_{CCA}	$V_{CCB} = 3.0\text{V}$ to 3.6V	$V_{CCB} = 2.3\text{V}$ to 2.7V	$V_{CCB} = 1.65\text{V}$ to 1.95V	$V_{CCB} = 1.4\text{V}$ to 1.6V	$V_{CCB} = 1.1\text{V}$ to 1.3V	Units
	Min.	Min.	Min.	Min.	Typ.	
$V_{CCA} = 3.00\text{V}$ to 3.60V	140	120	100	80	40	Mbps
$V_{CCA} = 2.30\text{V}$ to 2.70V	120	120	100	80	40	Mbps
$V_{CCA} = 1.65\text{V}$ to 1.95V	100	100	80	60	40	Mbps
$V_{CCA} = 1.40\text{V}$ to 1.60V	80	80	60	60	40	Mbps
$V_{CCA} = 1.10\text{V}$ to 1.30V	Typ.	Typ.	Typ.	Typ.	Typ.	
	40	40	40	40	40	Mbps

Notes:

13. Maximum data rate is guaranteed, but not tested.
14. Maximum data rate is specified in megabits per second (see *Figure 9*). It is equivalent to two times the F-toggle frequency, specified in megahertz. For example, 100Mbps is equivalent to 50MHz.

Capacitance

Symbol	Parameter	Conditions	$T_A = +25^\circ\text{C}$ Typical	Units	
C_{IN}	Input Capacitance Control Pin (/OE)	$V_{CCA} = V_{CCB} = \text{GND}$	3	pF	
$C_{I/O}$	Input/Output Capacitance	A_n	4	pF	
		B_n	5		
C_{pd}	Power Dissipation Capacitance		$V_{CCA} = V_{CCB} = 3.3\text{V}$, $V_I = 0\text{V}$ or V_{CC} , $f = 10\text{MHz}$	25	pF

I/O Architecture Benefit

The FXLA101 I/O architecture benefits the end user, beyond level translation, in the following three ways:

Auto Direction without an external direction pin.

Drive Capacitive Loads. Automatically shifts to a higher current drive mode only during “Dynamic Mode” or HL / LH transitions.

Lower Power Consumption. Automatically shifts to low-power mode during “Static Mode” (no transitions), lowering power consumption.

The FXLA101 does not require a direction pin. Instead, the I/O architecture detects input transitions on both side and automatically transfers the data to the corresponding output. For example, for a given channel, if both A and B side are at a static LOW, the direction has been established as A → B, and a LH transition occurs on the B port; the FXLA101 internal I/O architecture automatically changes direction from A → B to B → A.

During HL / LH transitions, or “Dynamic Mode,” a strong output driver drives the output channel in parallel with a weak output driver. After a typical delay of approximately 10ns – 50ns, the strong driver is turned off, leaving the weak driver enabled for holding the logic state of the channel. This weak driver is called the “bus

hold.” “Static Mode” is when only the bus hold drives the channel. The bus hold can be over ridden in the event of a direction change. The strong driver allows the FXLA101 to quickly charge and discharge capacitive transmission lines during dynamic mode. Static mode conserves power, where I_{CC} is typically $< 5\mu A$.

Bus Hold Minimum Drive Current

Specifies the minimum amount of current the bus hold driver can source/sink. The bus hold minimum drive current (I_{HOLD}) is V_{CC} dependent and guaranteed in the DC Electrical tables. The intent is to maintain a valid output state in a static mode, but that can be overridden when an input data transition occurs.

Bus Hold Input Overdrive Drive Current

Specifies the minimum amount of current required (by an external device) to overdrive the bus hold in the event of a direction change. The bus hold overdrive (I_{IODH} , I_{IOLD}) is V_{CC} dependent and guaranteed in the DC Electrical tables.

Dynamic Output Current

The strength of the output driver during LH / HL transitions is referenced on page 8, *Dynamic Output Electrical Characteristics, I_{OHD} , and I_{OLD}* .

Test Diagrams

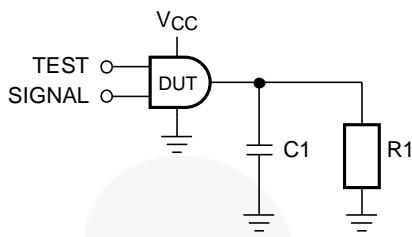


Figure 3. Test Circuit

Table 1. AC Test Conditions

Test	Input Signal	Output Enable Control
t_{PLH}, t_{PHL}	Data Pulses	0V
t_{PZL}	0V	HIGH to LOW Switch
t_{PZH}	V_{CCI}	HIGH to LOW Switch

Table 2. AC Load

V_{CCO}	$C1$	$R1$
$1.2V \pm 0.1V$	15pF	$1M\Omega$
$1.5V \pm 0.1V$	15pF	$1M\Omega$
$1.8V \pm 0.15V$	15pF	$1M\Omega$
$2.5V \pm 0.2V$	15pF	$1M\Omega$
$3.3V \pm 0.3V$	15pF	$1M\Omega$

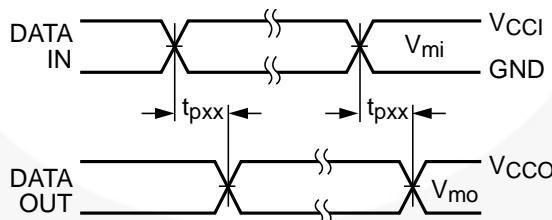


Figure 4. Waveform for Inverting and Non-Inverting Functions

Notes:

15. Input $t_R = t_F = 2.0\text{ns}$, 10% to 90%.
16. Input $t_R = t_F = 2.5\text{ns}$, 10% to 90%, at $V_I = 3.0\text{V}$ to 3.6V only.

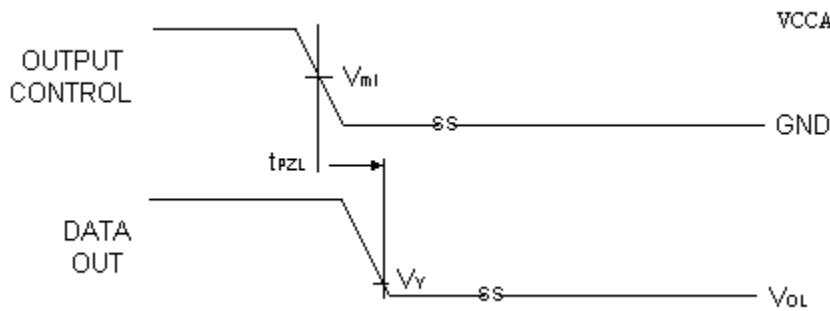


Figure 5. 3-State Output Low Enable Time for Low Voltage Logic

Notes:

17. Input $t_R = t_F = 2.0\text{ns}$, 10% to 90%.
 18. Input $t_R = t_F = 2.5\text{ns}$, 10% to 90%, at $V_I = 3.0\text{V}$ to 3.6V only.

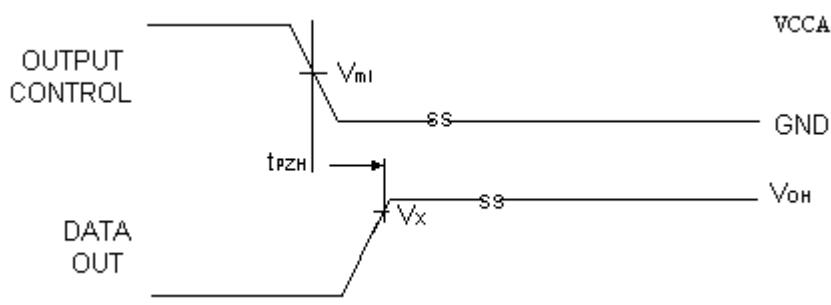


Figure 6. 3-State Output High Enable Time for Low Voltage Logic

Notes:

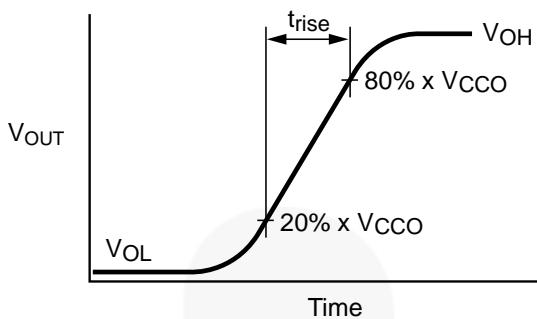
19. Input $t_R = t_F = 2.0\text{ns}$, 10% to 90%.
 20. Input $t_R = t_F = 2.5\text{ns}$, 10% to 90%, at $V_I = 3.0\text{V}$ to 3.6V only.

Table 3. Test Measure Points

Symbol	V_{DD}
$V_{MI}^{(21)}$	$V_{CCI}/2$
V_{MO}	$V_{CCO}/2$
V_X	$0.9 \times V_{CCO}$
V_Y	$0.1 \times V_{CCO}$

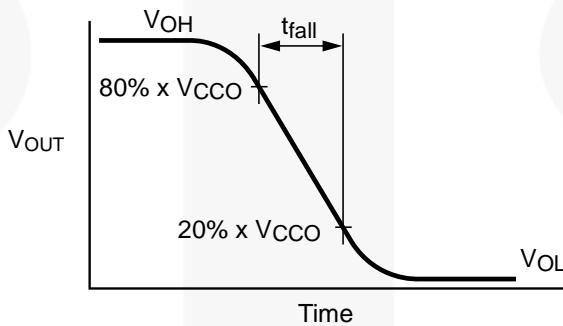
Note:

21. $V_{CCI}=V_{CCA}$ for control pin /OE or $V_{MI}=(V_{CCA}/2)$.



$$I_{OHD} \approx (C_L + C_{I/O}) \times \frac{\Delta V_{OUT}}{\Delta t} = (C_L + C_{I/O}) \times \frac{(20\% - 80\%) \cdot V_{CCO}}{t_{RISE}}$$

Figure 7. Active Output Rise Time and Dynamic Output Current High



$$I_{OLD} \approx (C_L + C_{I/O}) \times \frac{\Delta V_{OUT}}{\Delta t} = (C_L + C_{I/O}) \times \frac{(80\% - 20\%) \cdot V_{CCO}}{t_{FALL}}$$

Figure 8. Active Output Fall Time and Dynamic Output Current Low

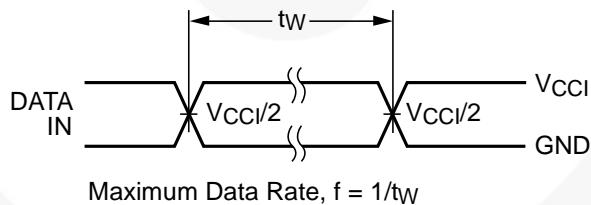


Figure 9. Maximum Data Rate

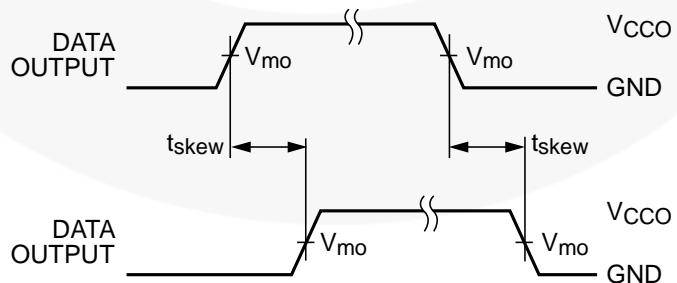


Figure 10. Output Skew Time

Note:

$$22. t_{SKEW} = (t_{pHLmax} - t_{pHLmin}) \text{ or } (t_{pLHmax} - t_{pLHmin})$$

Physical Dimensions

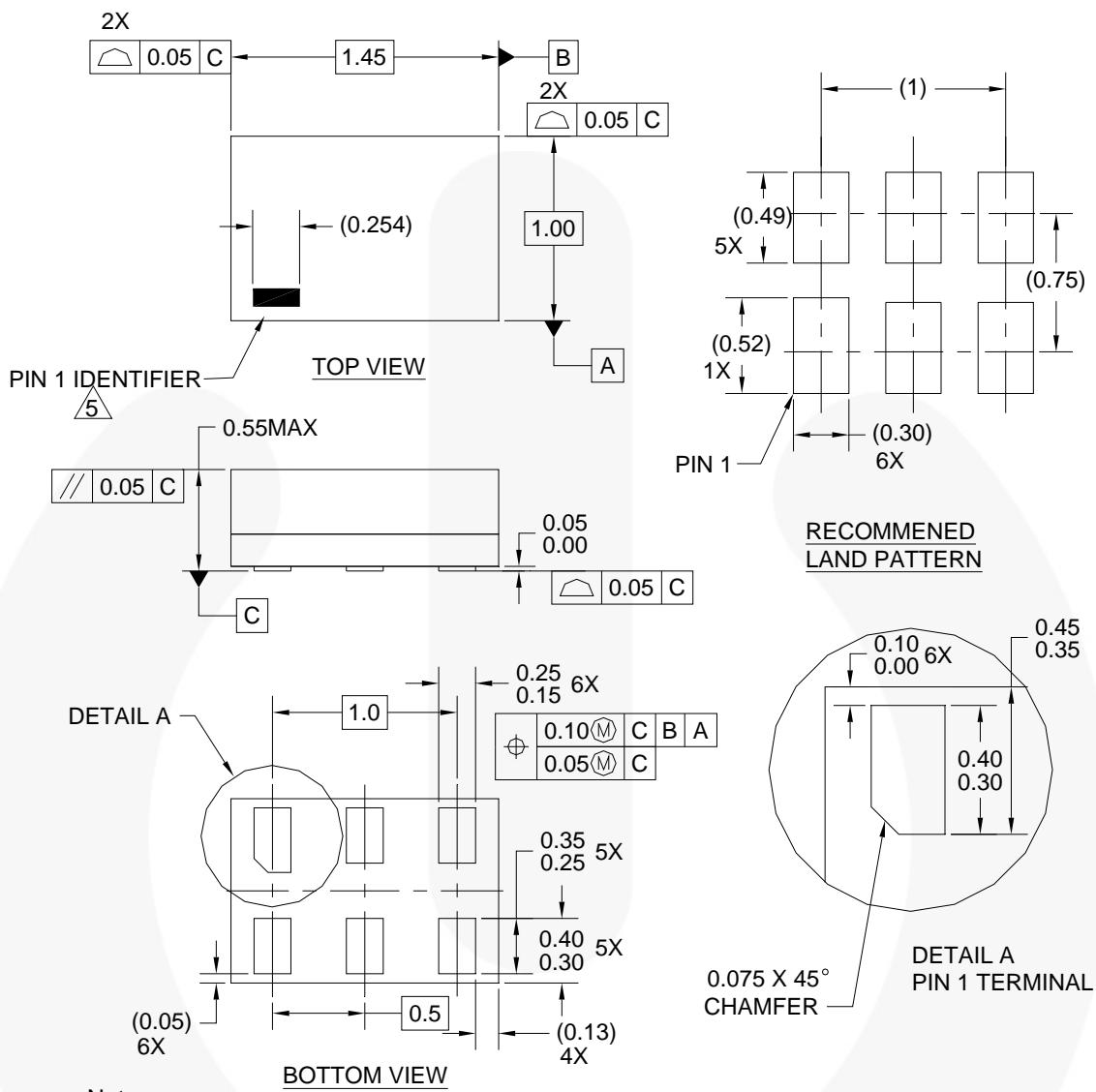


Figure 11.6-Lead MicroPak™ 1.00mm x 1.45mm Package

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Physical Dimensions

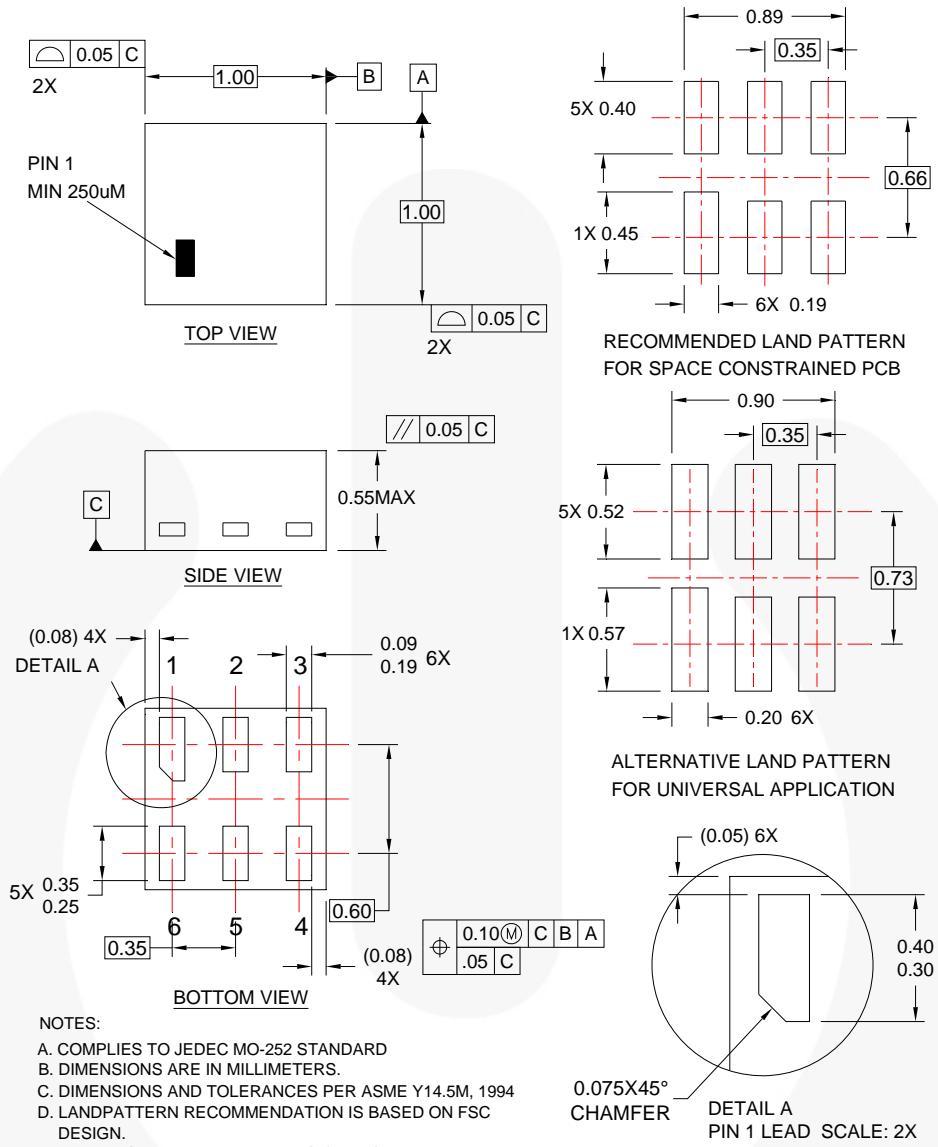


Figure 12.6-1 lead MicroPak2, 1x1mm Body, .35mm Pitch

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Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
FHX	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed



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